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Part Number: [0430450624](#)
Status: **Active**
Overview: [Micro-Fit Connector System](#)
Description: Micro-Fit 3.0 Vertical Header, 3.00mm Pitch, Dual Row, 6 Circuits, with PCB Press-fit Metal Retention Clip, Tin, Glow-Wire Capable, Black

Documents:

Drawing (PDF)	Test Summary 430450004-TS-000 (PDF)
3D Model	Test Summary TS-43045-001-001 (PDF)
3D Model (PDF)	Test Summary TS-46235-001-001 (PDF)
Product Specification 430450001-PS-KO-000 (PDF)	Datasheet (PDF)
Product Specification 430450001-PS-SP-000 (PDF)	Symbol Footprint Data SYM-43045-0624-001 (PDF)
Product Specification PS-43045-001 (PDF)	Symbol Footprint Data SYM-43045-06246-001 (PDF)
Packaging Specification PK-70873-0314-001 (PDF)	RoHS Certificate of Compliance (PDF)

Agency Certification

CSA	LR19980
UL	E29179

General

Product Family	PCB Headers
Series	43045
Application	Power, Wire-to-Board
Comments	High Temperature Square Pin Offset Through Hole Mounting Solder Type<P><P>This Molex product is manufactured from material that has the following ratings, tested by independent agencies:. a) A Glow Wire Ignition Temperature (GWIT) of at least 775 deg C per IEC 60695-2-13.. b) A Glow Wire Flammability Index (GWFI) above 850 deg C per IEC 60695-2-12.and hence complies with the requirements set out in the International Standard IEC 60335-1 5th edition - household and similar electrical appliances - safety, section 30 Resistance to heat and fire. <P><P> The customers using this product must determine its suitability for use in their particular application through testing or other acceptable means as described in end-product glow-wire flammability test standard IEC 60695-2-11 and any applicable product end-use standard(s). <P> If it is determined during the customer's evaluation of suitability, that higher performance is required, please contact Molex for possible product options. High Temperature Square Pin Offset Through Hole Mounting Solder Type<P><P>This Molex product is manufactured from material that has the following ratings, tested by independent agencies:. a) A Glow Wire Ignition Temperature (GWIT) of at least 775 deg C per IEC 60695-2-13.. b) A Glow Wire Flammability Index (GWFI) above 850 deg C per IEC 60695-2-12.and hence complies with the requirements set out in the International Standard IEC 60335-1 5th edition - household and similar electrical appliances - safety, section 30 Resistance to heat and fire. <P><P> The customers using this product must determine its suitability for use in their particular application through testing or other acceptable means as described in end-product glow-wire flammability test standard IEC 60695-2-11 and any applicable product end-use standard(s). <P> If it is determined during the customer's evaluation of suitability, that higher performance is required, please contact Molex for possible product options.
Overview	Micro-Fit Connector System
Product Name	Micro-Fit 3.0
UPC	800753816336

Physical

Breakaway	No
Circuits (Loaded)	6
Circuits (maximum)	6
Color - Resin	Black
Durability (mating cycles max)	30
Flammability	94V-0
Glow-Wire Capable	Yes
Mated Height	17.64mm
Material - Metal	Brass



Series image - Reference only

EU ELV

Not Relevant

EU RoHS

Compliant

REACH SVHC

Not Contained Per -
D(2020)9139-DC (19
Jan 2021)

Halogen-Free

Status

Low-Halogen

For more information, please visit [Contact US](#)

China RoHS

China ROHS	Green Image
ELV	Not Relevant
RoHS Phthalates	Not Contained

Search Parts in this Series

[43045 Series](#)

Mates With

Micro-Fit 3.0 Receptacle Housing [43025](#)
. Micro-Fit 3.0 TPA Receptacle Housing
[172952](#) . Micro-Fit 3.0 Cable Assembly
[245132](#) , [214755](#) , [214756](#) . Micro-Fit TPA
Cable Assembly [45132](#)

Material - Plating Mating	Tin
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	1.084/g
Number of Rows	2
Orientation	Vertical
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.60mm
Packaging Type	Tray
Pitch - Mating Interface	3.00mm
Plating min - Mating	0.254µm
Polarized to PCB	Yes
Shrouded	Fully
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-40° to +105°C
Termination Interface: Style	Through Hole - Kinked Pin
Electrical	
Current - Maximum per Contact	8.5A
Voltage - Maximum	600V
Solder Process Data	
Duration at Max. Process Temperature (seconds)	030
Lead-freeProcess Capability	SMC&WAVE
Max. Cycles at Max. Process Temperature	003
Process Temperature max. C	260
Material Info	
Reference - Drawing Numbers	
Packaging Specification	PK-70873-0314-001
Product Specification	430450001-PS-KO-000, 430450001-PS-SP-000, PS-43045-001
Sales Drawing	SD-43045-009-001
Symbol/Footprint Data	SYM-43045-0624-001, SYM-43045-0624_6-001
Test Summary	430450004-TS-000, TS-43045-001-001, TS-46235-001-001

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